

Description

The SJPB-L6 is a 60 V, 3.0 A Schottky diode with allowing improvements in V_F and I_R characteristics.

These characteristic features contribute to improving power supply efficiency and to enabling high-frequency systems.

Features

- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Suitable for High Reliability and Automotive Requirement

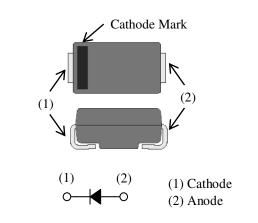
Applications

High speed switching applications as follows:

- DC-DC Converter
- Adapter

Package





Not to scale

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25 \circ C$				
Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V _{RSM}		60	V
Repetitive Peak Reverse Voltage	V _{RM}		60	V
Average Forward Current	I _{F(AV)}	See Figure 2 and Figure 3	3.0	А
Surge Forward Current	I _{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	50	А
I ² t Limiting Value	I ² t	$1 \text{ ms} \le t \le 10 \text{ ms}$	8.0	A ² s
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T _{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	$V_{\rm F}$	$I_{\rm F} = 3.0 ~\rm{A}$	_	0.61	0.7	V
Reverse Leakage Current	I _R	$V_R = V_{RM}$	_	_	0.3	mA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 \ ^\circ C$			70	mA
Thermal Resistance ⁽¹⁾	$R_{th(J-L)}$				20	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight			0.072		g

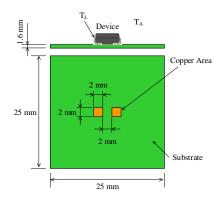


Figure 1. Lead Temperature Measurement Conditions

 $^{^{(1)}}$ R_{th (J-L)} is thermal resistance between junction and lead. Lead temperature (T_L) is measured near the root of pin (see Figure 1).

Derating Curves

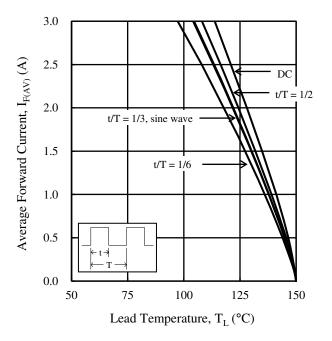


Figure 2. $I_{F(AV)}$ vs. $T_L (T_J = 150 \text{ °C}, V_R = 0 \text{ V})$

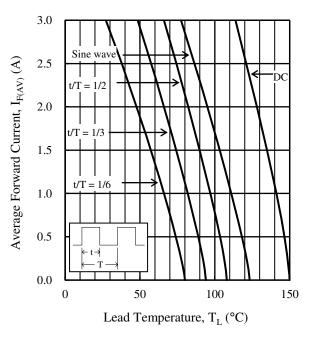


Figure 3. $I_{F(AV)}$ vs. $T_L (T_J = 150 \text{ °C}, V_R = 60 \text{ V})$

Characteristic Curves

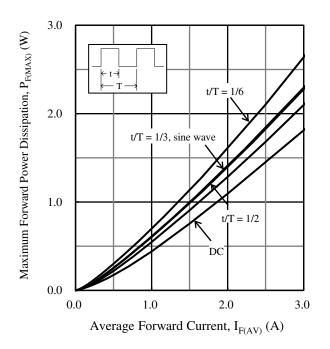


Figure 4. $P_{F(MAX)}$ vs. $I_{F(AV)}$ (T_J = 150 °C)

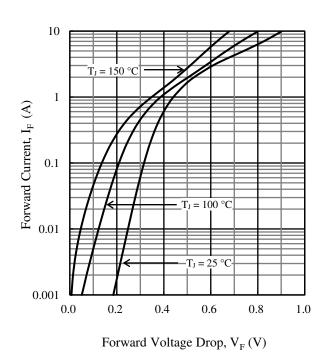


Figure 6. Typical Characteristics: I_F vs. V_F

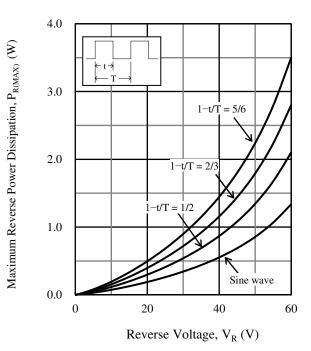


Figure 5. $P_{R(MAX)}$ vs. V_R ($T_J = 150 \ ^{\circ}C$)

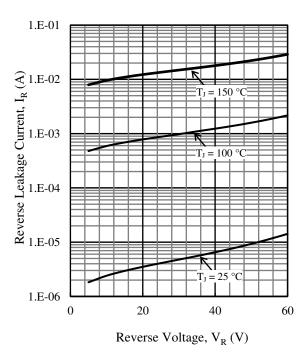


Figure 7. Typical Characteristics: I_R vs. V_R

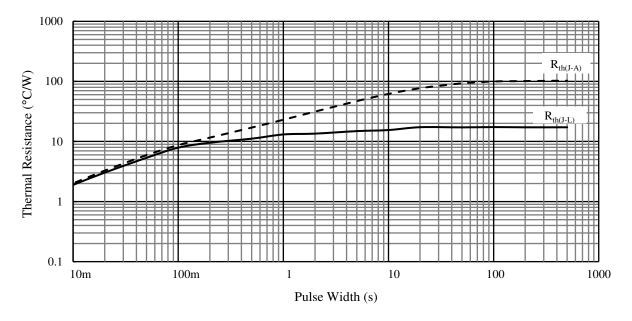
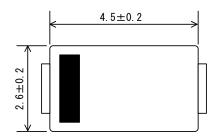
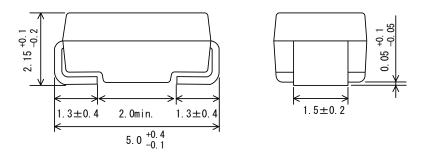


Figure 8. Typical Transient Thermal Resistance Characteristics

Physical Dimensions

• SJP Package



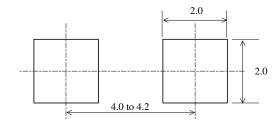


NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)
- When soldering the products, be sure to minimize the working time within the following limits:
- Flow: 260 °C / 10 s, 1 time Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s Solder heating: 255 °C / 30 s, 3 times (260 °C peak) Soldering Iron: 350 °C / 3.5 s, 1 time

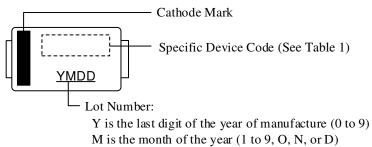
• SJP Land Pattern Example



NOTE:

- Dimensions in millimeters

Marking Diagram



DD is the day of the month (01 to 31)

Table 1. Specific Device Code

Specific Device Code	Part Number
BL6	SJPB-L6

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